A wide variety of products including dust-proof type









Items	Specifications
Rating (max.)	50mA 12V DC
Rating (min.)	10 µA 1V DC
Initial contact resistance	100mΩ max.
Travel (mm)	0.25

■ Product Line

Top push type

Product No.	Operating force	Operating	Operating life	Stem color	Height	Minimum ord	Drawing	
	.,	direction	(5mA 5V DC)			Japan	Export	No.
SKHUAKE010	0.98N		300,000 cycles	Green	2.5mm	3,000	3,000	1
SKHUALE010	1.57N	Top push	300,000 cycles	Black				
SKHUAME010	2.55N		100,000 cycles	Red				

With ground terminal type

Product No.	Operating force	Operating	Operating life			Minimum ord	Drawing	
T TOUGOT TVO.	operating force	direction	(5mA 5V DC)	010111 00101	rioigrit	Japan	Export	No.
SKHUPKE010	0.98N		300 000 avalas	Green	2.5mm	3,000	3,000	
SKHUPLE010	1.57N	Top push	300,000 cycles -	Black				2
SKHUPME010	2.55N		100,000 cycles	Red				

Dust-proof type

Product No.	Operating force	Operating			Height	Minimum ord	Drawing	
T TOUGET NO.	direction (5	(5mA 5V DC)	Sterri Golor	I COIOI I IEIGITE	Japan	Export	No	
SKHUBHE010	1.57N	Top push	50,000 cycles	Brown	3.1mm	3,000	3,000	3

Dust-proof and with ground terminal type

Product No.	Operating force	Operating	Operating life	Stem color	Height	Minimum order unit (pcs.)		Drawing	
T TOUGET NO.	Operating force	direction	(5mA 5V DC)	Otern color	I IEIBIIL	Japan	Export	No	
SKHUQHE010	1.57N	Top puch	F0.000 avalas	Brown	0.1	3.000	3.000	4	
SKHUQGE010	2.55N	Top push	50,000 cycles	Red	3.1mm	3,000	3,000	4	

■ Packing Specifications

Taping

Num	ber of packages (Tape width	Export package	
1 reel	1 case / Japan	1 case / export packing	(mm)	measurements (mm)
3,000	30,000	30,000	12	395×395×205

Unit:mm Reel size

For reels of 330mm diameter, please inquire.



■ Dimensions

No.	Photo	Style	PC board land dimensions (Viewed from switch mounting face)
1	Top push type	7.2 6.2 1 1 2 1 3 1 1 1 1 1 1 1 1 1 1 1 1 1 1	81 4 9.5
2	With ground terminal type	7.2 6.2 0.2 0.2 0.2 0.2 0.2 0.2 0.2 0.2 0.2 0	9.5 4 Ground terminal land Q 4 3.1
3	Dust-proof type	7.2 6.2 V. Stem	9.5
4	Dust-proof and with ground terminal type	7.2 6.2 1 2 1 2 1 2 1 3 5 5 8 9 1 8 9 1 8 1 8 1 8 1 8 1 8 1 8 1 8 1	9.5 Ground terminal land

■ Circuit Diagram

	Med to the
Top push type	With ground terminal type
①	1) 2 3 4 5 4



					Sharp Fe	eling Type			
	Type				Surfac	e Mount			
	Series	SKST	SKRA	SKHM	SKHU	SKTD	SKSN	SKTG	SKSL
	Photo	Qu'i			C				0,4
	Features	Middle	e travel	_	_	Low-profile	Mid-mount	Half-n	nount
	Water-proof	_	0	_	0	•	_	•	_
	Dust-proof	_	0	_	0	•	_	•	_
	IP standard	_	67 equivalent	_	_	67 equivalent	_	67 equivalent	_
Operatir	Top push	•	•	•	•	_	_	_	_
directio		_	_	_	_	•	•	•	•
	W			6.2	6.2	3.9	6.2	5.2	4.5
Dimension (mm)		□8.5	□6.2	6.5	6.3	2.9	3	3.5	2.6
(11111)	Н	3.95	3.5/5.2	3.1	2.5/3.1	1.55	3.5	1.55	2.2
Operation force coverage	2N to 3N	4N to 10N		Ì	1	\$	1	\$	1
	Travel (mm)	0.9	See the relevant pages for respective product description	0.25		0.15	0.2	0.15	
G	round terminal	_	_	•	•	•	•	•	•
Operatin	ng temperature range	-40°C 1	to +90°C	-40℃	to +85℃	−30°C to +85°C	-40°C to +85°C	-30°C t	o +85℃
А	utomotive use	•	0	_	0	_	_	_	_
	Life Cycle	* 2	*3	*3	*3	* 2	* 2	2	* 2
	Rating (max.) (Resistive load)	50mA 16V DC	1		1	50mA 12V DC			
Electrical	Rating (min.) (Resistive load)				10μΑ	V IV DC			
performance	Insulation resistance				100MΩ min.	100V DC 1min.			
	Voltage proof		250V A	C 1min. 100V AC			250V A	C 1min.	100V AC 1min.
D. rashilita	Vibration		10 to 5	55 to 10Hz/n in the 3 dire	nin., the amplite	ude is 1.5mm fo	r all the freque respectively	encies,	
Durability	Lifetime			Shall be in	accordance wi	ith individual spe	ecifications.		
	Cold	-40℃	1,000h			-40°C	C 96h		
Environmental performance	Dry heat	90℃	1,000h	90°C	96h	85℃ 96h	90°C 96h	85℃ 96h	90℃ 96h
	Damp heat		to 95%RH 00h			60°C, 90 to 9	95%RH 96h		
Page		230	231	232	233	235	236	237	238

W : Width. The most outer dimension excluding terminal portion. D : Depth. The most outer dimension excluding terminal portion.

H: Height. The minimum dimension if there are variances.

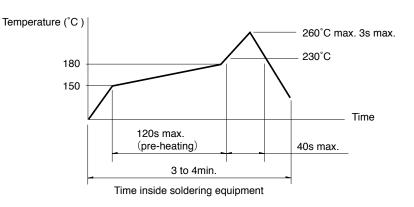
ACT Switch™ Soldering Conditions · · · · · · · · · · · · · · · · · · ·	
ACT Switch™Cautions · · · · · · · · · · · · · · · · · · ·	

Notes

- 1. The automotive operating temperature range to be individually discussed upon request.
- 2. lacktriangle Indicates applicability to all products in the series, while \bigcirc indicates applicability to some products in the series.

TACT Switch™ / Soldering Conditions

■ Condition for Reflow Available for Surface Mount Type. Temperature profile



Notes

- 1. Please confirm the specifications of our product for the detailed condition.
- Soldering conditions differ depending on reflow soldering machines. Prior verification of soldering condition is highly recommended.

■ Conditions for Auto-dip

Available for Snap-in Type and Radial Type.

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 100°C max.
Preheating time	60s max.
Soldering temperature	260℃ max.
Duration of immersion	5s max.
Number of soldering	2times max.

SKHH Series

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 110°C max.
Preheating time	60s max.
Soldering temperature	260℃ max.
Duration of immersion	5s max.
Number of soldering	2times max.

SKHL Top Push Type, SKQJ Series

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 100°C max.
Preheating time	45s max.
Soldering temperature	255℃ max.
Duration of immersion	5s max.
Number of soldering	2times max.

■ Manual Soldering

Items	Condition
Soldering temperature	350℃ max.
Duration of soldering	3s max.
Capacity of soldering iron	60W max.

SKHH, SKHW Series

Items	Condition
Soldering temperature	360°C max.
Duration of soldering	3s max.
Capacity of soldering iron	60W max.

SKTD, SKTG, SKQJ Series

Items	Condition
Soldering temperature	350°C max.
Duration of soldering	3s max.
Capacity of soldering iron	20W max.

Notes

- 1. Prevent flux penetration from the top side of the TACT Switch™.
- 2. Switch terminals and a PC board should not be coated with flux prior to soldering.
- 3. The second soldering should be done after the switch is stable with normal temperature.
- 4. Use the flux with a specific gravity of min 0.81. (EC-19S-8 by TAMURA CORPORATION, or equivalents.)



单击下面可查看定价,库存,交付和生命周期等信息

>>ALPS Electric (阿尔卑斯)